N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220Rev. 02 — 1 November 2010Product data

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel MOSFET in TO-220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive

1.3 Applications

- DC-to-DC converters
- Load switching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. **Quick reference data**

| | quient i or or or or or out | | | | | | |
|----------------------|----------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | N | lin | Тур | Мах | Unit |
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | | - | 80 | V |
| I _D | drain current | $T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> | - | | - | 90 | A |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see Figure 2 | - | | - | 170 | W |
| Tj | junction temperature | | -5 | 55 | - | 175 | °C |
| Static char | racteristics | | | | | | |
| R _{DSon} | drain-source on-state resistance | $\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ T_{j} = 100 \text{ °C}; \text{ see } \underline{\text{Figure } 12} \end{array}$ | - | | - | 14 | mΩ |
| | | V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; see <u>Figure 13</u> | <u>[1]</u> - | | 7.5 | 8.7 | mΩ |
| Dynamic o | haracteristics | | | | | | |
| Q _{GD} | gate-drain charge | V_{GS} = 10 V; I_{D} = 25 A; | - | | 11 | - | nC |
| Q _{G(tot)} | total gate charge | $V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15}$ | - | | 52 | - | nC |
| Avalanche | ruggedness | | | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | $ \begin{array}{l} V_{GS} = 10 \text{ V}; T_{j(\text{init})} = 25 ^\circ\text{C}; \\ I_D = 90 \text{ A}; V_{sup} \leq 80 \text{ V}; \\ \text{R}_{GS} = 50 \Omega; \text{ unclamped} \end{array} $ | - | | - | 120 | mJ |
| | | | | | | | |

[1] Measured 3 mm from package.



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2. Pinning information

| Table 2. | Pinning | j information | | |
|----------|---------|-----------------------------------|--------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | G | gate | | _ |
| 2 | D | drain | mb | |
| 3 | S | source | | |
| mb | D | mounting base; connected to drain | | mbb076 S |
| | | | SOT78 (TO-220AB) | |

3. Ordering information

Table 3.Ordering information

| Type number | Package | | |
|--------------|----------|----------------------------------------------------------------------------------|---------|
| | Name | Description | Version |
| PSMN8R7-80PS | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

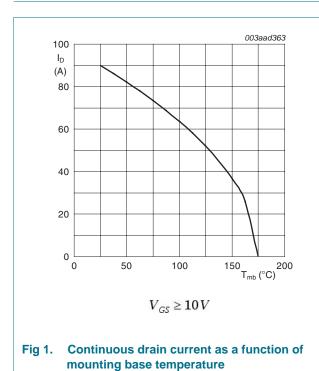
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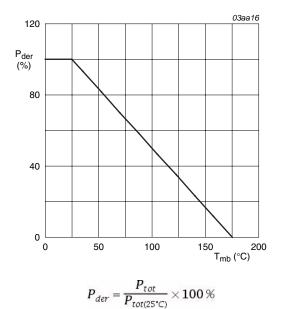
4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Cumb al | Devenueter | Conditions | N/1: | Max | 11 |
|----------------------|-------------------------------------------------|-----------------------------------------------------------------------------------------------------------------|------|-----|------|
| Symbol | Parameter | Conditions | Min | Мах | Unit |
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | 80 | V |
| V _{DGR} | drain-gate voltage | $T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$ | - | 80 | V |
| V _{GS} | gate-source voltage | | -20 | 20 | V |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u> | - | 64 | А |
| | | V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u> | - | 90 | А |
| I _{DM} | peak drain current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3 | - | 361 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | - | 170 | W |
| T _{stg} | storage temperature | | -55 | 175 | °C |
| Tj | junction temperature | | -55 | 175 | °C |
| T _{sld(M)} | peak soldering temperature | | - | 260 | °C |
| Source-drain | diode | | | | |
| I _S | source current | T _{mb} = 25 °C | - | 90 | А |
| I _{SM} | peak source current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$ | - | 361 | А |
| Avalanche ru | ggedness | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 90 A; $V_{sup} \le 80$ V; R_{GS} = 50 Ω ; unclamped | - | 120 | mJ |

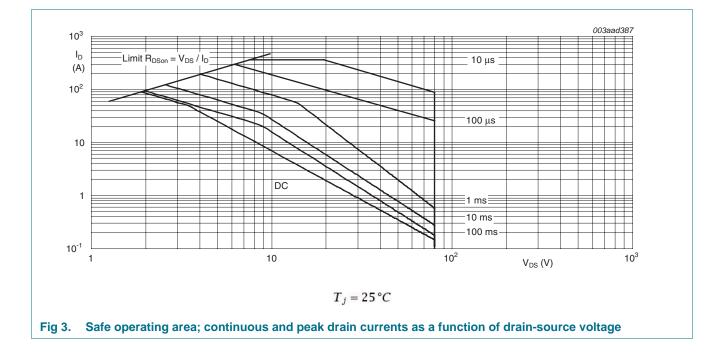






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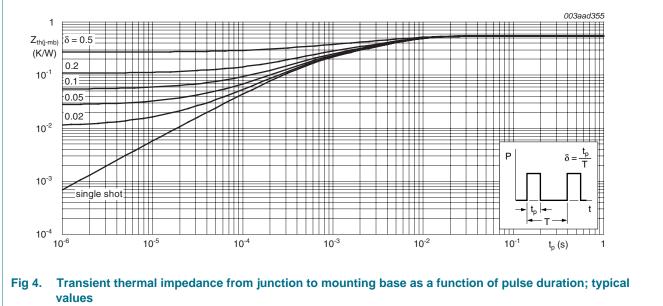


PSMN8R7-80PS Product data sheet N-channel 80 V 8.7 mΩ standard level MOSFET in TO-220

Thermal characteristics 5.

Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------------------|---------------------|-----|------|------|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | see <u>Figure 4</u> | - | 0.54 | 0.88 | K/W |



N-channel 80 V 8.7 m Ω standard level MOSFET in TO-220

6. Characteristics

Table 6. Characteristics

Tested to JEDEC standards where applicable.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------------------------------------|-----------------------------------|-------------------------------------------------------------------------------------------------------------------------|--------------|------|-----------|------|
| Static char | acteristics | | | | | |
| V _{(BR)DSS} | drain-source breakdown voltage | $I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$ | 73 | - | - | V |
| | | $I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$ | 80 | - | - | V |
| V _{GS(th)} gate-source | gate-source threshold voltage | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 10</u> | 1 | - | - | V |
| | | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 10 | - | - | 4.6 | V |
| | | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 10</u> | 2.3 | 3 | 4 | V |
| I _{DSS} | drain leakage current | $V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.3 | 5 | μA |
| | | $V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$ | - | - | 100 | μA |
| I _{GSS} | gate leakage current | V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C | - | 10 | 100 | nA |
| | | $V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 10 | 100 | nA |
| R _{DSon} drain-source on-state resistance | drain-source on-state resistance | V _{GS} = 10 V; I _D = 10 A; T _j = 175 °C; see <u>Figure 12</u> | - | - | 20.8 8 | mΩ |
| | | V _{GS} = 10 V; I _D = 10 A; T _j = 100 °C; see <u>Figure 12</u> | - | - | 14 | mΩ |
| | | V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; see <u>Figure 13</u> | <u>[1]</u> - | 7.5 | 8.7 | mΩ |
| R _G | internal gate resistance (AC) | f = 1 MHz | - | 1 | - | Ω |
| Dynamic o | haracteristics | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$ | - | 44 | - | nC |
| | | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ | - | 52 | - | nC |
| Q _{GS} | gate-source charge | see Figure 14; see Figure 15 | - | 15 | - | nC |
| Q _{GS(th)} | pre-threshold gate-source charge | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ | - | 9.2 | - | nC |
| Q _{GS(th-pl)} | post-threshold gate-source charge | see Figure 14 | - | 5.8 | - | nC |
| Q_{GD} | gate-drain charge | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15 | - | 11 | - | nC |
| V _{GS(pl)} | gate-source plateau voltage | $I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 15}{100000000000000000000000000000000000$ | - | 4.6 | - | V |
| C _{iss} | input capacitance | $V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$ | - | 3346 | - | pF |
| C _{oss} | output capacitance | $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{1000}$ | - | 296 | - | pF |
| C _{rss} | reverse transfer capacitance | | - | 158 | - | pF |
| t _{d(on)} | turn-on delay time | V_{DS} = 40 V; R_{L} = 1.6 Ω; V_{GS} = 10 V; | - | 21 | - | ns |
| t _r | rise time | $R_{G(ext)} = 4.7 \Omega$ | - | 26 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 46 | - | ns |
| t _f | fall time | | - | 20 | - | ns |
| Source-dra | ain diode | | | | | |
| V_{SD} | source-drain voltage | I _S = 10 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 17</u> | - | 0.79 | 1.2 | V |

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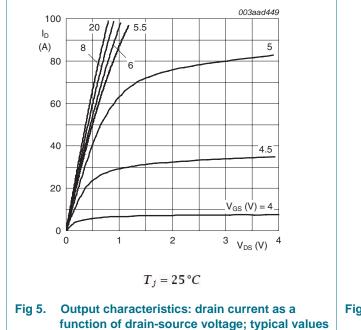
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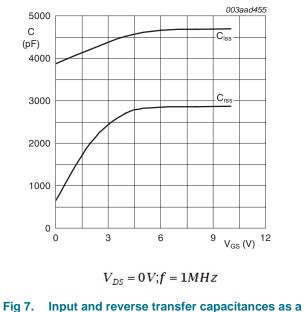
Table 6. Characteristics ...continued

Tested to JEDEC standards where applicable.

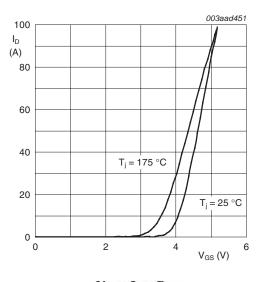
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-----------------------|------------------------------------------------------------------------------|-----|-----|-----|------|
| t _{rr} | reverse recovery time | $I_{S} = 25 \text{ A}; \text{ d}_{S}/\text{d}t = 100 \text{ A}/\mu\text{s};$ | - | 42 | - | ns |
| Qr | recovered charge | $V_{GS} = 0 V; V_{DS} = 40 V$ | - | 66 | - | nC |

[1] Measured 3 mm from package.



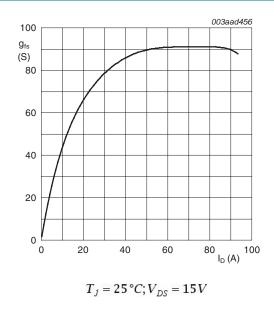






 $V_{DS} > I_D \times R_{DSon}$

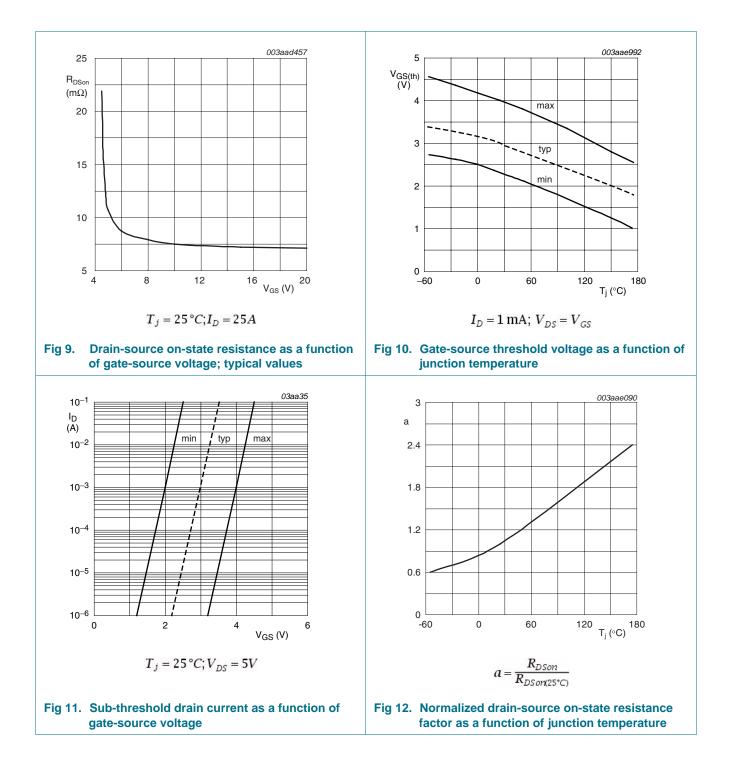






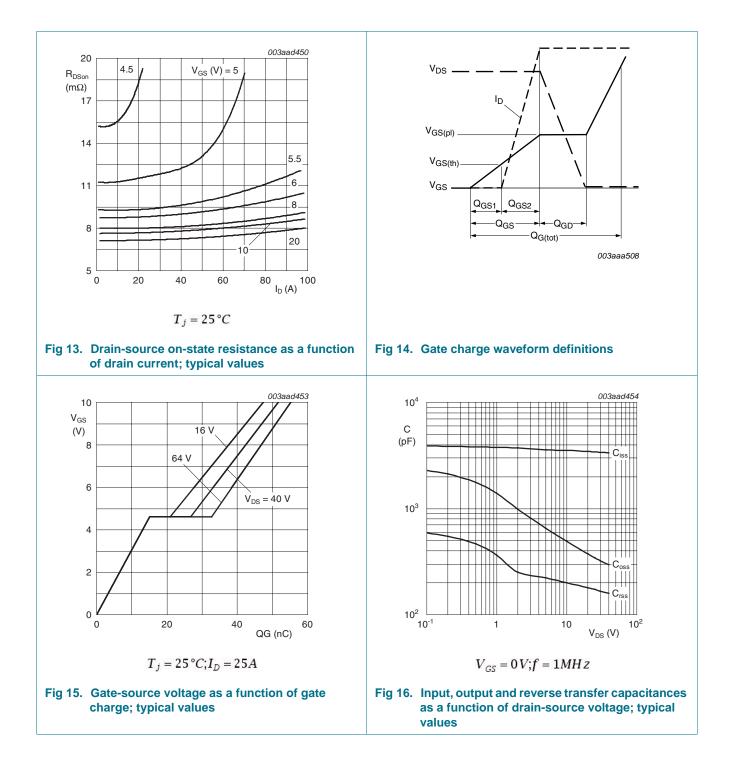
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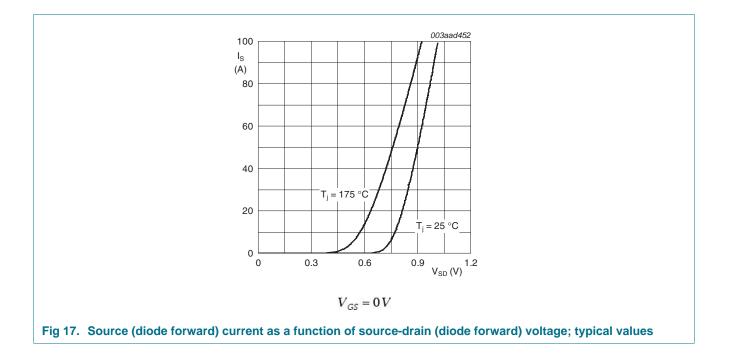
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Package outline 7.

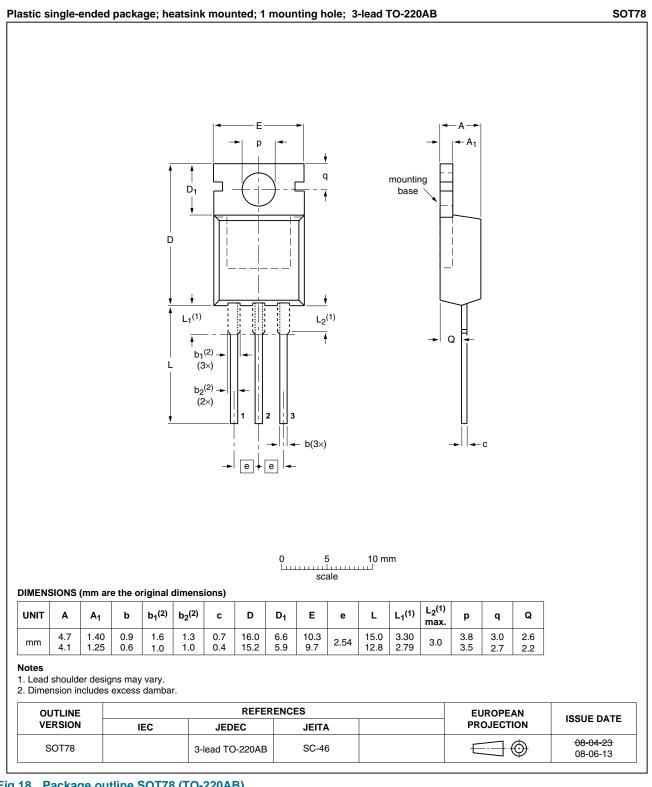


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

| Table 7. Revision h | nistory | | | |
|---------------------|-----------------------------------|------------------------------|---------------|------------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PSMN8R7-80PS v.2 | 20101101 | Product data sheet | - | PSMN8R7-80PS v.1 |
| Modifications: | Status change | d from objective to product. | | |
| | Various chang | es to content. | | |
| PSMN8R7-80PS v.1 | 20100129 | Objective data sheet | - | - |

PSMN8R7-80PS Product data sheet

9. Legal information

9.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PSMN8R7-80PS

N-channel 80 V 8.7 m Ω standard level MOSFET in TO-220

11. Contents

| 1 | Product profile |
|-----|--------------------------|
| 1.1 | General description1 |
| 1.2 | Features and benefits1 |
| 1.3 | Applications1 |
| 1.4 | Quick reference data1 |
| 2 | Pinning information2 |
| 3 | Ordering information2 |
| 4 | Limiting values3 |
| 5 | Thermal characteristics5 |
| 6 | Characteristics6 |
| 7 | Package outline11 |
| 8 | Revision history12 |
| 9 | Legal information13 |
| 9.1 | Data sheet status |
| 9.2 | Definitions |
| 9.3 | Disclaimers |
| 9.4 | Trademarks14 |
| 10 | Contact information14 |

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